

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSV)**2SK3499**

Switching Regulator and DC-DC Converter Applications  
Motor Drive Applications

- Low drain-source ON resistance:  $R_{DS(ON)} = 0.4 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 8.0 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 100 \mu\text{A}$  (max) ( $V_{DS} = 400 \text{ V}$ )
- Enhancement-model:  $V_{th} = 2.0$  to  $4.0 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1 \text{ mA}$ )

**Maximum Ratings (Ta = 25°C)**

| Characteristics                                      |                | Symbol    | Rating     | Unit |
|--|----------------|-----------|------------|------|
| Drain-source voltage                                 |                | $V_{DSS}$ | 400        | V    |
| Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ ) |                | $V_{DGR}$ | 400        | V    |
| Gate-source voltage                                  |                | $V_{GSS}$ | $\pm 30$   | V    |
| Drain current  | DC (Note 1)    | $I_D$     | 10         | A    |
|  | Pulse (Note 1) | $I_{DP}$  | 40         |      |
| Drain power dissipation ( $T_c = 25^\circ\text{C}$ ) |                | $P_D$     | 80         | W    |
| Single pulse avalanche energy (Note 2)               |                | $E_{AS}$  | 360        | mJ   |
| Avalanche current                                    |                | $I_{AR}$  | 10         | A    |
| Repetitive avalanche energy (Note 3)                 |                | $E_{AR}$  | 8          | mJ   |
| Channel temperature                                  |                | $T_{ch}$  | 150        | °C   |
| Storage temperature range                            |                | $T_{stg}$ | -55 to 150 | °C   |

**Thermal Characteristics**

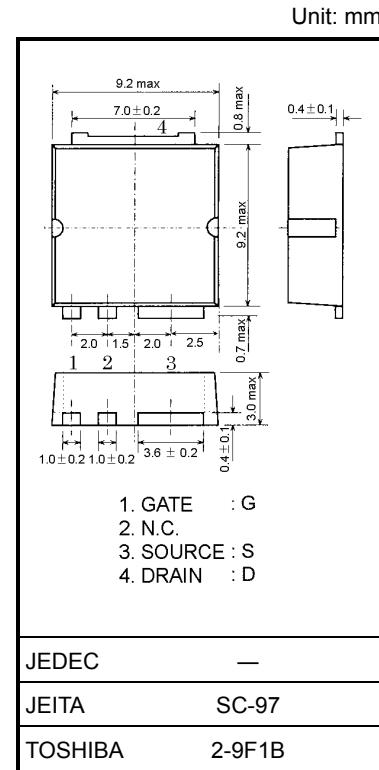
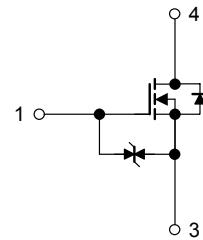
| Characteristics                     | Symbol                | Max  | Unit |
|-------------------------------------|-----------------------|------|------|
| Thermal resistance, channel to case | $R_{th}(\text{ch-c})$ | 1.56 | °C/W |

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 5.85 \text{ mH}$ ,  $R_G = 25 \Omega$ ,  $I_{AR} = 10 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

**Circuit Configuration**

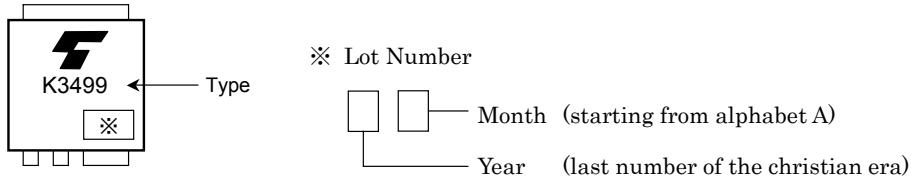
Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

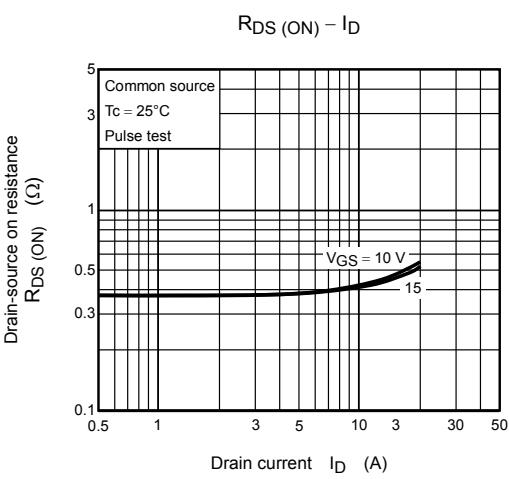
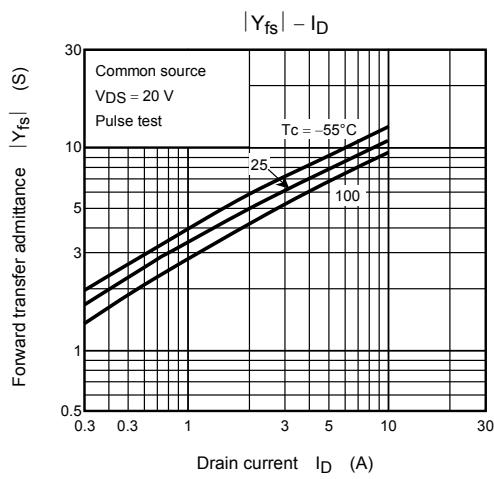
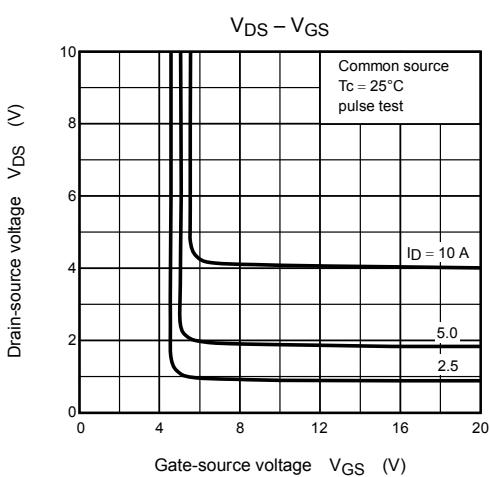
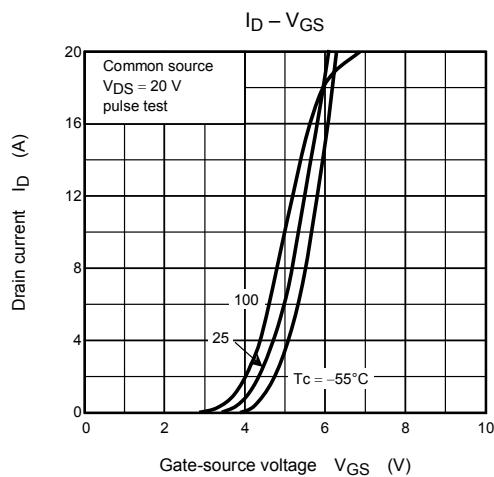
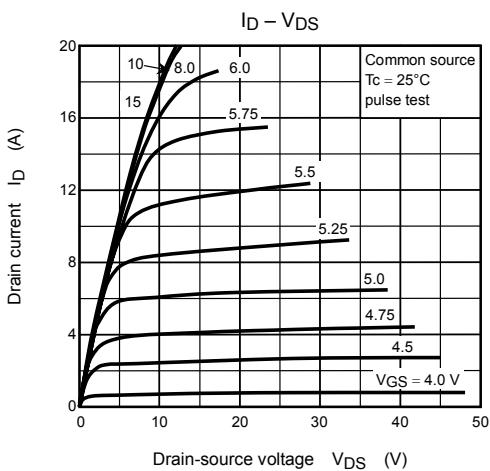
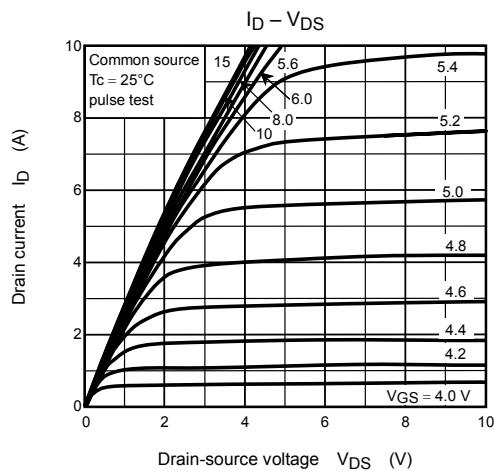
| Characteristics                                 | Symbol                       | Test Condition   | Min                        | Typ. | Max      | Unit          |    |
|---|------------------------------|--|----------------------------|------|----------|---------------|----|
| Gate leakage current                            | $I_{GSS}$                    | $V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$                        | —                          | —    | $\pm 10$ | $\mu\text{A}$ |    |
| Drain-source breakdown voltage                  | $V_{(\text{BR})\text{ GSS}}$ | $I_G = \pm 10\text{ }\mu\text{A}, V_{DS} = 0\text{ V}$                 | $\pm 30$                   | —    | —        | $\text{V}$    |    |
| Drain cut-OFF current                           | $I_{DSS}$                    | $V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}$                           | —                          | —    | 100      | $\mu\text{A}$ |    |
| Drain-source breakdown voltage                  | $V_{(\text{BR})\text{ DSS}}$ | $I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$                              | 400                        | —    | —        | $\text{V}$    |    |
| Gate threshold voltage                          | $V_{th}$                     | $V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$                              | 2.0                        | —    | 4.0      | $\text{V}$    |    |
| Drain-source ON resistance                      | $R_{DS(\text{ON})}$          | $V_{GS} = 10\text{ V}, I_D = 5.0\text{ A}$                             | —                          | 4.0  | 0.55     | $\Omega$      |    |
| Forward transfer admittance                     | $ Y_{fs} $                   | $V_{DS} = 10\text{ V}, I_D = 5.0\text{ A}$                             | 4.0                        | 0.8  | —        | $\text{S}$    |    |
| Input capacitance                               | $C_{iss}$                    | $V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$          | —                          | 1340 | —        | $\text{pF}$   |    |
| Reverse transfer capacitance                    | $C_{rss}$                    |  | —                          | 160  | —        |               |    |
| Output capacitance                              | $C_{oss}$                    |  | —                          | 490  | —        |               |    |
| Switching time                                  | Rise time                    | $t_r$  | <br>$V_{GS}$ (0 V to 10 V) | —    | 22       | —             | ns |
|   | Turn-ON time                 | $t_{on}$   |                            | —    | 60       | —             |    |
|   | Fall time                    | $t_f$  |                            | —    | 32       | —             |    |
|   | Turn-OFF time                | $t_{off}$  |                            | —    | 140      | —             |    |
| Total gate charge (gate-source plus gate-drain) | $Q_g$                        | $V_{DD} \approx 320\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$ | —                          | 34   | —        | nC            |    |
| Gate-source charge                              | $Q_{gs}$                     |  | —                          | 18   | —        |               |    |
| Gate-drain ("miller") charge                    | $Q_{gd}$                     |  | —                          | 16   | —        |               |    |

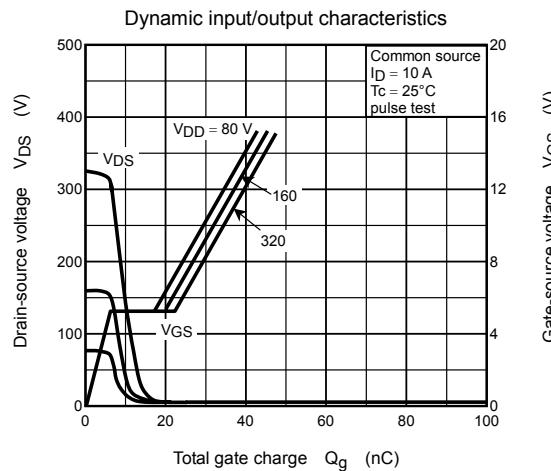
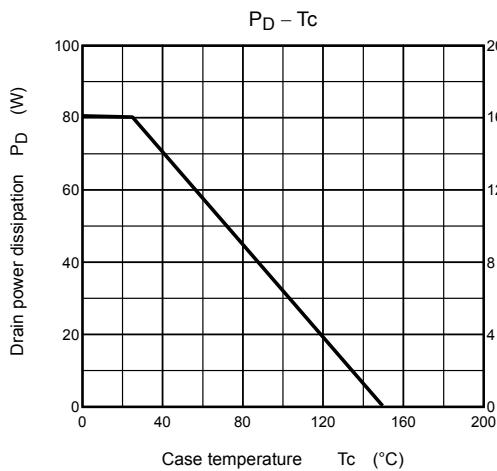
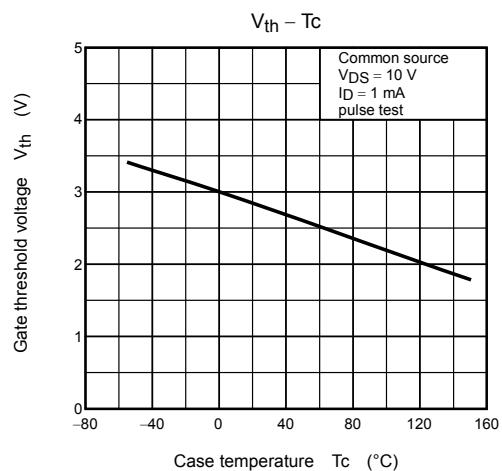
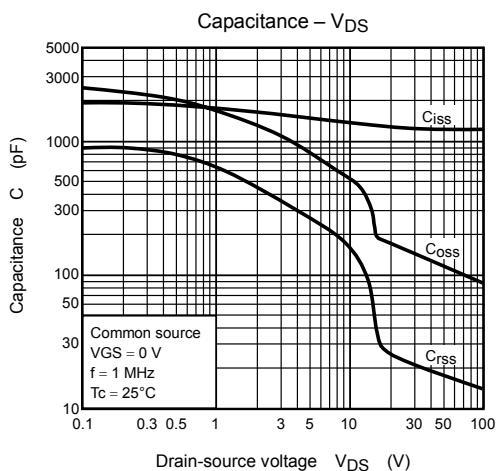
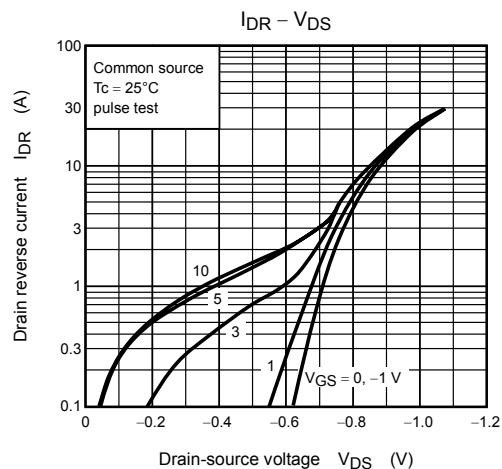
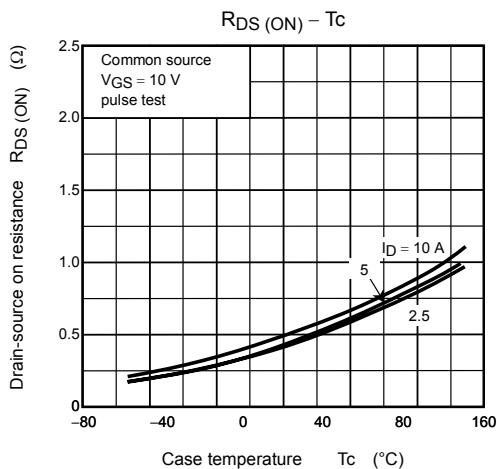
Source-Drain Ratings and Characteristics ( $T_a = 25^\circ\text{C}$ )

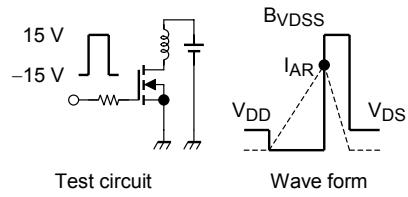
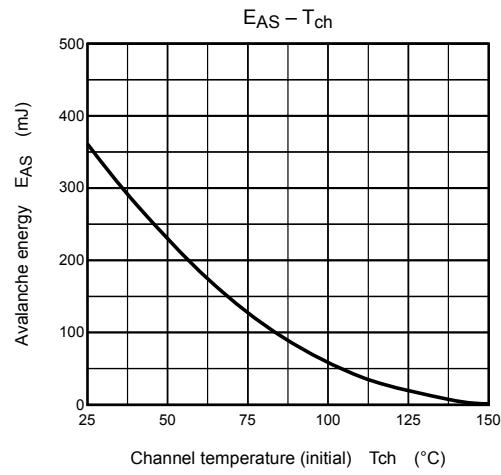
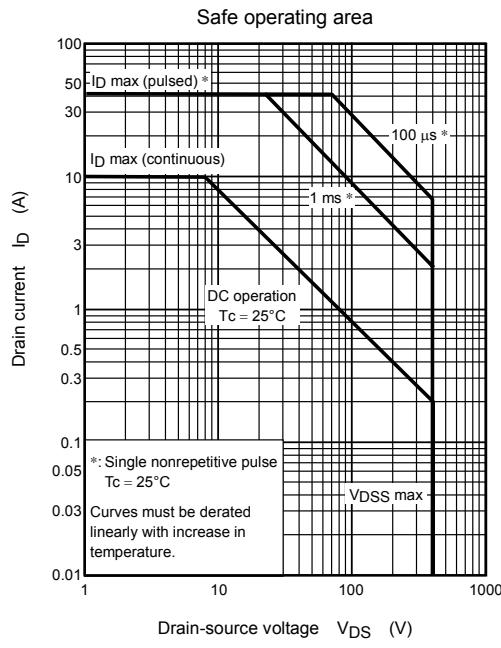
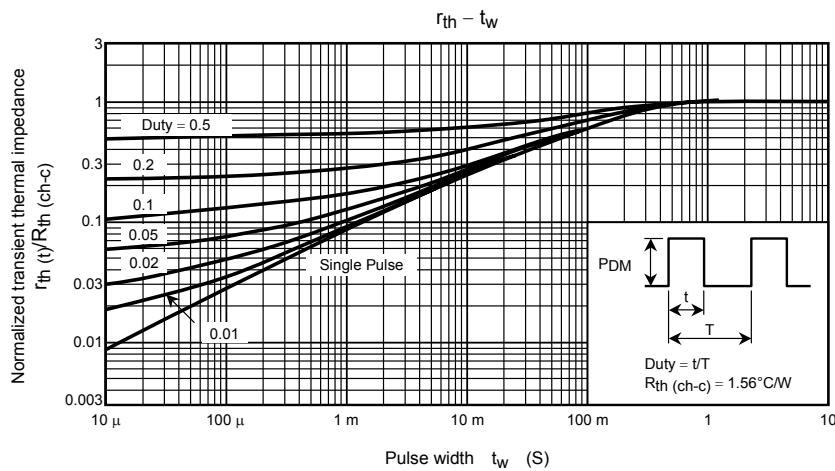
| Characteristics                           | Symbol    | Test Condition  | Min | Typ. | Max  | Unit          |
|---|-----------|---|-----|------|------|---------------|
| Continuous drain reverse current (Note 1) | $I_{DR}$  | —   | —   | —    | 10   | $\text{A}$    |
| Pulse drain reverse current (Note 1)      | $I_{DRP}$ | —   | —   | —    | 40   | $\text{A}$    |
| Forward voltage (diode)                   | $V_{DSF}$ | $I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V}$   | —   | —    | -1.7 | $\text{V}$    |
| Reverse recovery time                     | $t_{rr}$  | $I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V},$<br>$dI_{DR}/dt = 100\text{ A}/\mu\text{s}$ | —   | 350  | —    | $\mu\text{s}$ |
| Reverse recovery charge                   | $Q_{rr}$  |   | —   | 3.6  | —    | $\mu\text{C}$ |

## Marking









$$R_G = 25 \Omega$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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